

Features

- Split Gate Trench MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low RDS(ON)

Product Summary

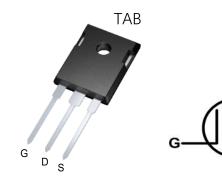


BVDSS	RDSON	ID
-100V	22 mΩ	-80 A

Applications

- DC-DC Converters
- Power management functions
- Synchronous-rectification applications

TO247 Pin Configuration



Absolute Maximum Ratings ($T_C=25^{\circ}C$ unless otherwise specified):

Symbol	Parameter		Value	Units
V _{DSS}	Drain-to-Source Voltage		-100	V
T_	Continuous Drain Current	$T_C = 25$ °C	-80	A
I_D	Continuous Drain Current	$T_C = 100 ^{\circ}C$	-41	A
I_{DM}^{a1}	Pulsed Drain Current		-260	A
V_{GS}	Gate-to-Source Voltage	±20	V	
P_D	Power Dissipation		250	W
T _J , T _{STG}	Operating Junction and Storage Temperature Range		150, -55 to 150	°C
T_{L}	Maximum Temperature for Solder	ring	260	°C

Thermal Characteristics:

Symbol	Parameter	Value	Units
$R_{ heta JC}$	Thermal Resistance, Junction-to-Case	0.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62	°C/W



Electrical Characteristics (T_J= 25°C unless otherwise specified):

Static Ch	Static Characteristics					
Cumbal	Donomoton	Test Conditions	Value			I India
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{DSS}	Drain to Source Breakdown Voltage	$V_{GS} = 0V, I_D = -250 \mu A$	-100			V
I_{DSS}	Drain to Source Leakage Current	$egin{array}{lll} V_{DS} &=& -100V, & V_{GS}= \\ 0V & & & \end{array}$			1	μΑ
$I_{GSS(F)}$	Gate to Source Forward Leakage	$V_{GS} = -20V$			100	nA
$I_{GSS(R)}$	Gate to Source Reverse Leakage	$V_{GS} = +20V$			-100	nA
$V_{GS(TH)} \\$	Gate Threshold Voltage	$V_{DS}=V_{GS}$, $I_{D}=-250\mu A$	-2	-3	-4	V
R _{DS(ON)}	Drain-to-Source On-Resistance	V _{GS} =-10V,I _D =-15A	1	22	25	mΩ

Dynamic	Dynamic Characteristics						
Crymbol	D	Test Conditions	Value			I India	
Symbol Parameter	rarameter		Min.	Typ.	Max.	Units	
C_{iss}	Input Capacitance	M OM		4200	1		
Coss	Output Capacitance	$V_{GS}=0V$ $V_{DS}=-50V$		536		pF	
Crss	Reverse Transfer Capacitance	f=1.0MHz		52		Ρ1	

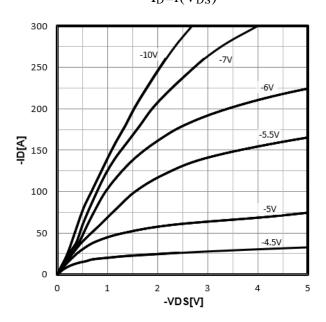
Resistive	Resistive Switching Characteristics						
Crymbol	D	T4 C414	Value			IIida	
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units	
$t_{d(ON)}$	Turn-on Delay Time	I_{D} =-15A, R_{L} =0.75 Ω		13			
tr	Rise Time	$V_{DS} = -50V$		51		12 G	
$t_{d(OFF)}$	Turn-Off Delay Time	$V_{GS} = -10V$		177		ns	
$t_{\rm f}$	Fall Time	$R_G = 3\Omega$		82			
Q_{g}	Total Gate Charge	$V_{GS}=-10V$		76			
Q_{gs}	Gate Source Charge	$V_{DS}=-50V$		13		nC	
Q_{gd}	Gate Drain Charge	$I_D=-15A$		12.4			

Source-D	rain Diode Characteristics						
C 1 1 D		T C. 1''	Value			TT '.	
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units	
Is	Diode Forward Current	T _C =25 °C			-80	Α	
V_{SD}	Diode Forward Voltage	$I_S=-15A, V_{GS}=0V$			-1.2	V	
t _{rr}	Reverse Recovery time	I_{S} =-15A, V_{DD} =-50V		110		ns	
Qrr	Reverse Recovery Charge	dI/dt=100A/μs		590		nC	

^{a1}: Repetitive rating; pulse width limited by maximum junction temperature

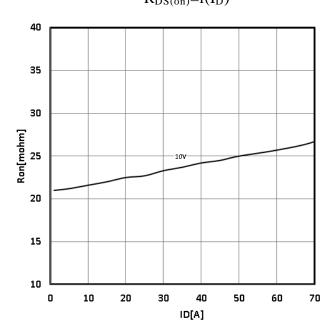


Typ. output characteristics $I_D\!\!=\!\!f(V_{\mathrm{DS}})$

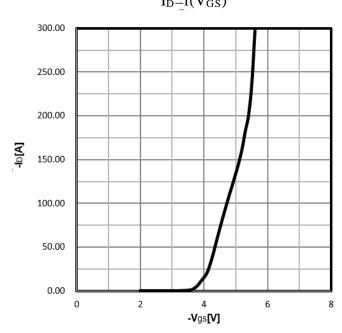


P-Ch 100V Fast Switching MOSFETs

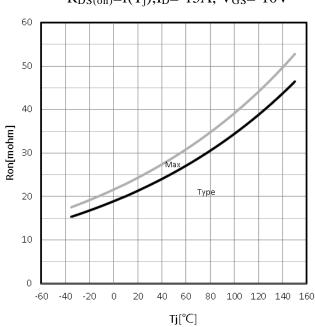
Typ. drain-source on resistance $R_{DS(on)} = f(I_D)$



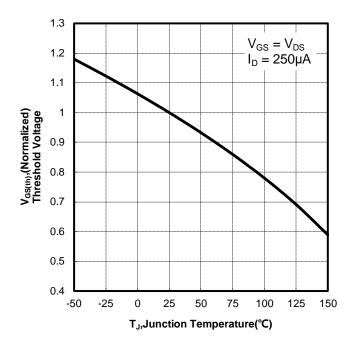
Typ. transfer characteristics $I_D = f(V_{\rm GS})$



 $\begin{array}{l} \textbf{Drain-source on-state resistance} \\ R_{DS(on)} \!\!=\!\! f(T_j); I_D \!\!=\!\! -15A; \ V_{GS} \!\!=\!\! -10V \end{array}$

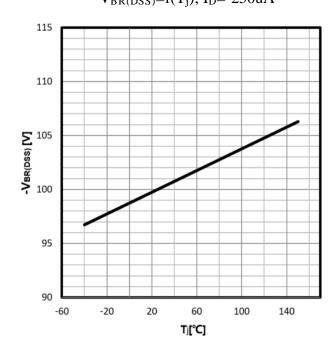




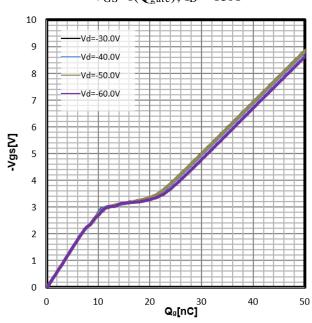


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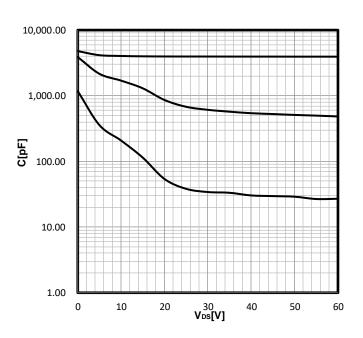
$\begin{array}{c} \textbf{Drain-source breakdown voltage} \\ V_{BR(DSS)} = f(T_i); \ I_D = -250 uA \end{array}$



Typ. gate charge V_{GS} = $f(Q_{gate}); I_D$ =-15A

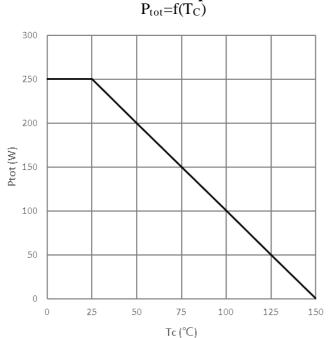


Typ. capacitances



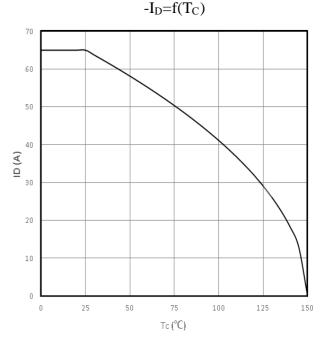


Power Dissipation

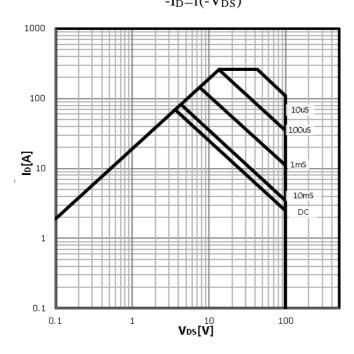


P-Ch 100V Fast Switching MOSFETs

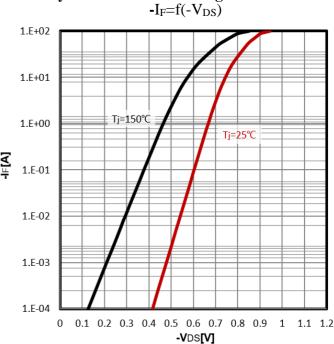
Maximum Drain Current



Safe operating area ${}_{\text{-}I_D} = f({}_{\text{-}}V_{DS})$

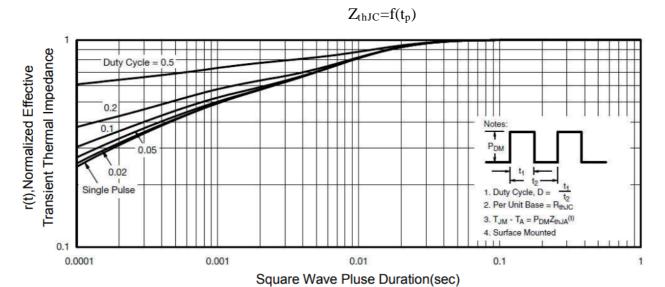


Body Diode Forward Voltage Variation





Max. transient thermal impedance

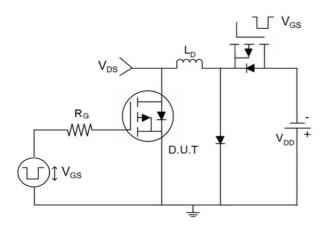


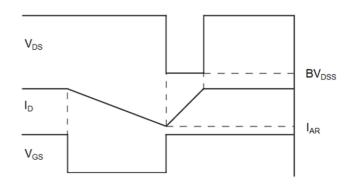


Test Circuit

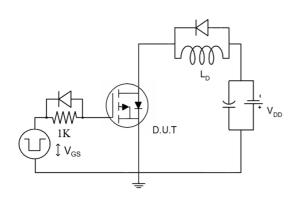
P-Ch 100V Fast Switching MOSFETs

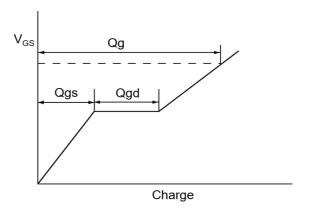
1) E_{AS} Test Circuits



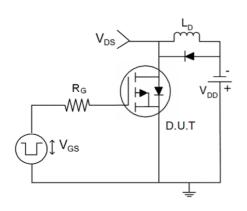


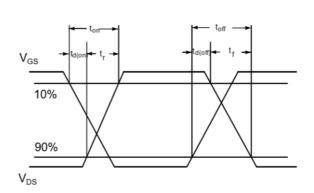
2) Gate Charge Test Circuit





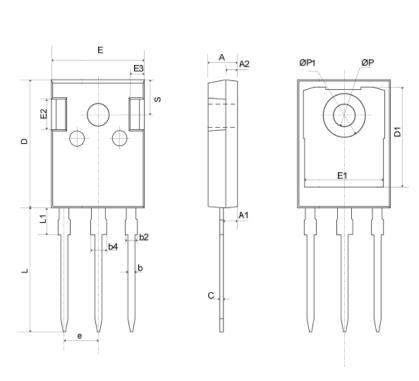
3) Switch Time Test Circuit







Mechanical Dimensions for TO-247



COMMON DIMENSIONS

	MM			
SYMBOL	MIN	MAX		
А	4.80	5.20		
A1	2.21	2.61		
A2	1.85	2.15		
b	1.11	1.36		
b2	1.91	2.21		
b4	2.91	3.21		
С	0.51	0.75		
D	20.70	21.30		
D1	16.25	16.85		
E	15.50	16.10		
E1	13.00	13.60		
E2	4.80	5.20		
E3	2.30	2.70		
e	5.44	BSC		
L	19.62	20.22		
L1		4.30		
ØP	3.40	3.80		
ØP1	_ 7.30			
S	6.15BSC			